

IEEE編輯傳授的投稿必備攻略

李箐

IEEE大中華區資訊經理

2019

議題

- 有的放矢-IEEE Journals or Conferences ?
- 脫穎而出-Peer Review Process
- 謹守分際-Ethics: Do&Don' t
- 通計熟籌-IEEE Submission Process
- 先利其器-IEEE Author Tools

IEEE簡介



The Institute of Electrical and Electronics Engineers

電氣電子工程師學會

現今的IEEE

- 非營利組織，全球最大的技術行業學會，成員遍佈160多個國家地區，會員超過42萬人



39個專業協會

IEEE Societies

- IEEE Aerospace and Electronic Systems Society
- IEEE Antennas and Propagation Society
- IEEE Broadcast Technology Society
- IEEE Circuits and Systems Society
- IEEE Communications Society
- IEEE Computational Intelligence Society
- IEEE Computer Society
- IEEE Consumer Electronics Society
- IEEE Control Systems Society
- IEEE Dielectric and Electrical Insulation Society
- IEEE Educational Activities Council
- IEEE Electron Devices Society
- IEEE Electronics Packaging Society
- IEEE Electromagnetic Compatibility Society
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- IEEE Geoscience and Remote Sensing Society
- IEEE Industrial Electronics Society
- IEEE Industry Applications Society
- IEEE Information Theory Society
- IEEE Instrumentation and Measurement Society
- IEEE Intelligent Transportation Systems Society
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- IEEE Microwave Theory and Techniques Society
- IEEE Nuclear and Plasma Sciences Society
- IEEE Oceanic Engineering Society
- IEEE Photonics Society
- IEEE Power Electronics Society
- IEEE Power & Energy Society
- IEEE Product Safety Engineering Society
- IEEE Systems, Man, and Cybernetics Society
- IEEE Technology and Engineering Management Society
- IEEE Ultrasonics, Ferroelectrics, and Frequency Control Society
- IEEE Vehicular Technology Society

IEEE涵蓋各個科技領域

More than just electrical engineering & computer science

- Aerospace & Defense
- Automotive Engineering
- Biomedical Engineering
- Biometrics
- Circuits & Systems
- Cloud Computing
- Communication Systems
- Computer Software
- Electronics
- Energy
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- Imaging
- Information Technology
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- Power Electronics
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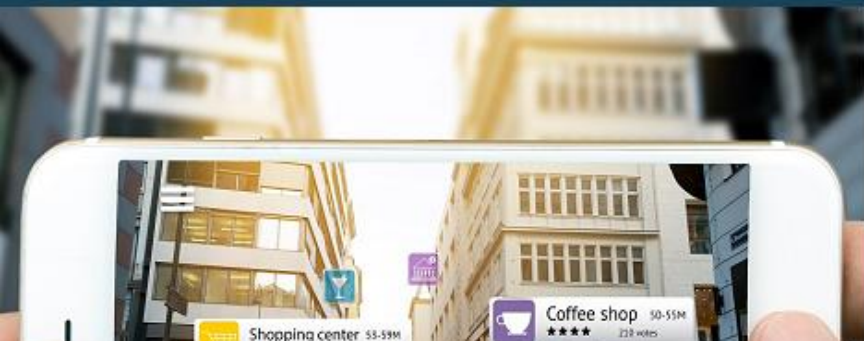
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- 19th International Conference on Advanced Information Networking and Applications (AINA'05) Volume 1 (AINA papers) (14)

有的放矢-IEEE Journals or Conferences ?

發表IEEE期刊或會議？

- 期刊文章是研究工作和最終結果的完整展示
 - 展示原創研究結果
 - 做出清晰推論，並輔以資料支援
- 會議文章可以是正在進行沒有完成的研究
 - 可展示初期成果或強調最近工作
 - 獲得非正式回饋用於後續研究
- 會議論文通常短於期刊論文,細節和參考文獻也少些

發表IEEE期刊或會議？

IEEE期刊



- IEEE期刊被引次數高



- 投稿期刊被拒機率高

IEEE會議

- IEEE會議論文是全球電子電氣電腦方向最重要內容

- 作者須現場展示論文後,文章才能收入IEEE Xplore

如何篩選合適投稿的期刊？

物聯網智慧城市相關研究的核心期刊是哪些？

- **Letters:** brief articles, fast publication
- **Journals and Transactions:** full-length research articles
- **Magazines:**
 - Feature articles: peer-reviewed, typically have fewer equations and references than a journal article
 - Columns such as editorials and society news are not reviewed

Publication Title



Enter Title

- IEEE Internet of Things Journal (55)
- IEEE Access (38)
- IEEE Communications Magazine (24)
- IEEE Internet Computing (12)
- IEEE Consumer Electronics Magazine (9)
- IEEE Transactions on Industrial Informatics (8)
- IEEE Sensors Journal (6)
- IEEE Communications Surveys & Tutorials (5)
- IEEE Wireless Communications (5)
- IEEE Transactions on Sustainable Computing (4)
- Computer (2)

核心刊舉例: IEEE Internet of Things Journal

Browse Journals & Magazines > IEEE Internet of Things Journal ... ?

IEEE Internet of Things Journal

IEEE三個技術協會聯合出版
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IEEE Communications Society
IEEE Computer Society.



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About Journal

IEEE Internet of Things (IoT) Journal publishes articles on the latest advances, as well as review articles, on the various aspects of IoT. Topics include IoT system architecture, IoT enabling technologies, IoT communication and networking protocols such as network coding, and IoT services and applications. Examples are IoT demands, impacts, and implications on sensors technologies, big data management, and future Internet design for various IoT use cases, such as smart cities, smart environments, smart homes, etc. The fields of interest include: IoT architecture such as things-centric, data-centric, service-oriented IoT architectures, IoT enabling technologies and systematic integration such as sensor technologies, big sensor data management, and future Internet design for IoT; IoT services, applications, and test-beds such as IoT service middleware, IoT application programming interface (API), IoT application design, and IoT trials/experiments, IoT standardization activities and technology development in different standard development organizations (SDO) such as IEEE, IETF, ITU, 3GPP, ETSI, etc.

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該期刊最熱點論文是哪些？

Latest Published Articles

Reinforcement Learning for Decentralized Trajectory Design in Cellular UAV Networks with Sense-and-Send Protocol

Jingzhi Hu ; Hongliang Zhang ; Lingyang Song

十月-17
2018

Joint Task Assignment, Transmission and Computing Resource Allocation in Multi-layer Mobile Edge Computing Systems

Pengfei Wang ; Chao Yao ; Zijie Zheng ; Guangyu Sun ; Lingyang Song

十月-16
2018

An Online Continuous Progressive Second Price Auction for Electric Vehicle Charging

Yang Zhang ; Qingyu Yang ; Qingyu Yang ; Wei Yu ; Dou An ; Donghe Li ; Wei Zhao

十月-16
2018

Optimized Computation Offloading Performance in Virtual Edge Computing Systems via Deep Reinforcement Learning

Xianfu Chen ; Honggang Zhang ; Celimuge Wu ; Shiwen Mao ; Yusheng Ji ; Mehdi Bennis

十月-16
2018

★ Popular Articles

Internet of Things for Smart Cities

Andrea Zanella ; Nicola Bui ; Angelo Castellani ; Lorenzo Vangelista ; Michele Zorzi

二月-14
2014

Blockchain Meets IoT: An Architecture for Scalable Access Management in IoT

Oscar Novo

三月-05
2018

Edge Computing: Vision and Challenges

Weisong Shi ; Jie Cao ; Quan Zhang ; Youhuizi Li ; Lanyu Xu

六月-09
2016

A Survey on Internet of Things: Architecture, Enabling Technologies, Security and Privacy, and Applications

Jie Lin ; Wei Yu ; Nan Zhang ; Xinyu Yang ; Hanlin Zhang ; Wei Zhao

三月-15
2017

A Vision of IoT: Applications, Challenges, and Opportunities With China Perspective

Shanzhi Chen ; Hui Xu ; Dake Liu ; Bo Hu ; Hucheng Wang

七月-09
2014

IEEE Internet of Things Journal投稿要求

- 快速出版
 - Submission-to-ePublication = 16.9 weeks
- 最近兩期特刊徵稿
 - Special Issue on Advanced Computational Technologies in Mobile Edge Computing for Internet of Things
 - Special Issue on The Convergence of Blockchain and IoT: Opportunities, Challenges and Solutions

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Title	Open Access Availability	Impact Factor	Submission to Publication Time in Xplo
Internet of Things Journal, IEEE	Open Access Available	5.863	16.6 Weeks
Computer	No Open Access	1.94	Not yet available
IT Professional	No Open Access	1.618	Not yet available
Pervasive Computing, IEEE	No Open Access	3.022	Not yet available

▼ **Conferences:** (440 results) Sort By: **Keyword Match (relevance)** [SHOW MAP](#)

Title Location	Country	Abstract Submission Deadline	Conference Date
2019 7th International Conference on Future Internet of Things and Cloud (FiCloud) Location: Divan Hotel Istanbul, Asker Ocağı Caddesi , No:1, Taksim, Istanbul, Turkey	Turkey	11 Mar 2019	26-28 Aug 2019
2019 IEEE International Conference on Smart Internet of Things (SmartIoT) Location: Tianjin University, Tianjin, China	China		09-11 Aug 2019
2019 IEEE International Conference on Internet of Things and Intelligence	Indonesia		05-07 Nov 2019

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ICC 2019 - 2019 IEEE International Conference on Communications

Full Paper Submission
Final submission date
Notification of acceptance

2018 IEEE International Conference on Compatibility and Electromagnetic Compatibility

Final submission date

IEEE INFOCOM 2020 - IEEE Conference on Computer Communications

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IEEE INFOCOM solicits research papers describing significant and innovative research contributions to the field of computer and data communication networks. We invite submissions on a wide range of research topics, spanning both theoretical and systems research.

Conference Details

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Abstract submission deadline: 24 Jul 2019

Full Paper Submission deadline: 31 Jul 2019

Final submission deadline: 10 Jan 2020

Notification of acceptance date: 28 Nov 2019

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Conference # 41043

2017 United States National Conference on Radio Science Meeting (USNC-URSI NRSM)

Boulder

脫穎而出-Peer Review Process

論文主體結構

Title 題目

Abstract 文摘

Keywords 關鍵字

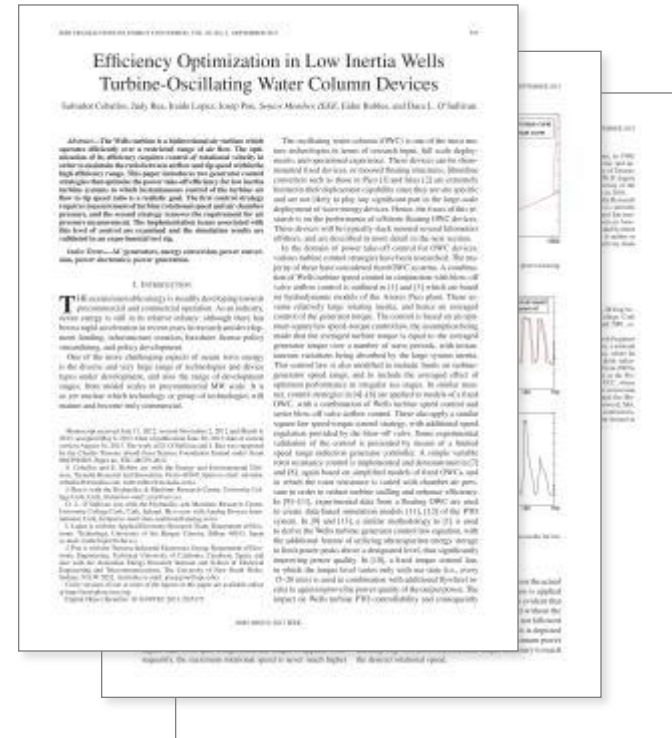
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Methodology 方法

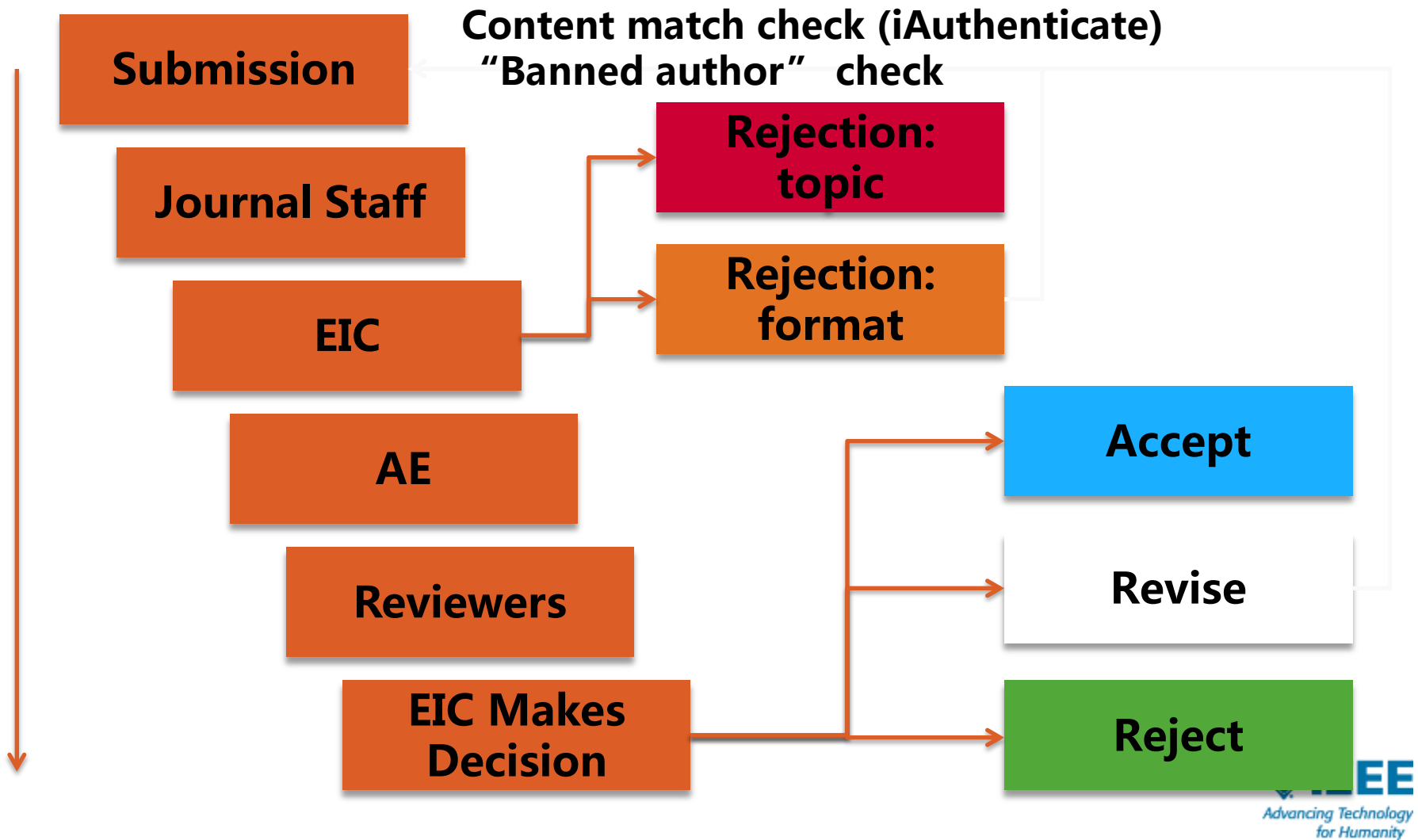
Results/Discussions/Findings 結果

Conclusion 總結

References 參考文獻



論文評審過程?



IEEE評審標準

- 內容符合期刊收錄範圍
- 清晰表達的原創研究，解決全新重要問題
- 有效的方法
- 有意義的結論
- 圖表圖像有力支援文字描述
- 能反映最近研究進展的相關參考文獻

IEEE編輯和評審人拒稿原因

- 內容不適合該期刊
- 嚴重的科學缺陷
 - 無法信服的結果或不正確的解釋
 - 學術造假
- 文筆差
- 沒有解決重大問題或提升當前科技水準
- 研究之前已經出版過
- 品質沒有達到期刊要求
- 評審人誤解文章

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We then have

$$\begin{aligned} (P_1^{h+} + P_1^{h-})^2 - (P_1^{g+} - P_1^{g-})^2 + 4P_1^{h+}P_1^{g-} \\ < (P_2^{h+} - P_2^{h-})^2 + 4P_2^{h+}P_2^{g-} \\ - (P_2^{g+} + P_2^{g-})^2 \end{aligned} \quad (32)$$

Since $P_1^{h+} - P_1^{h-} = P_1^{g+} - P_1^{g-}$, we then have $P_2^{g+} < P_1^{h+}$, and $P_2^{g-} < P_1^{h-}$. Because the operational cost is an increasing function of $\{P_2^{g+}, P_1^{h-}\}$, we obtain that

$$c_{0/10}(P_2^{g+}, P_1^{h-}) < c_{0/10}(P_1^{g+}, P_1^{h-}). \quad (33)$$

Therefore the optimal pair $\{P_1^{h+}, P_1^{g-}\}$ must satisfy that $P_1^{g+}P_1^{h-} = 0$, i.e., only one of P_1^{g+}, P_1^{h-} can be non-zero. ■

REFERENCES

- [1] "Renewable: Energy You can Count on," Tech. Rep. Union of Concerned Scientists, 2011.
- [2] S. Collier, "Ten steps to a smarter grid," *IEEE Ind. Appl. Mag.*, vol. 16, no. 2, pp. 62-68, 2010.
- [3] J. A. Turner, "A sustainable renewable energy future," *Sci.*, vol. 285, no. 5423, pp. 487-489, 1999.
- [4] "Exploration of High-Penetration Renewable Electricity Future," Tech. Rep. National Renewable Energy Lab., 2012.
- [5] T. Wiedmann and J. Minx, *A Depletion of 'Carbon Footprint'*. Harpenden, NY, USA: Nova Science, 2008.
- [6] J. Carmaco, L. Prasadulo, J. Hladaniewicz, E. Galvaz, R. Guisado, M. Prata, J. Laco, and N. Moreno-Alfonso, "Power-electronic systems for the grid integration of renewable energy sources: A survey," *IEEE Trans. Ind. Electron.*, vol. 53, no. 4, pp. 1002-1016, 2006.
- [7] H. Ibrahim, A. Elnasir, and J. Farnas, "Energy storage systems - characteristics and comparison," *Renewable Sustainable Energy Rev.*, vol. 12, no. 5, pp. 1223-1250, 2008.
- [8] J. Garcia-Gonzalez, R. de la Muela, L. Santas, and A. Gonzalez, "Stochastic joint optimization of wind generation and pumped-storage units in an electricity market," *IEEE Trans. Power Syst.*, vol. 23, no. 2, pp. 460-468, 2008.
- [9] T. D. Nguyen, K.-J. Tsang, S. Zhang, and T. D. Nguyen, "On the modeling and control of a novel flywheel energy storage system," in *Proc. IEEE Conf.*, 2010, pp. 1395-1401.
- [10] H. Zhou, T. Bhattacharya, D. Tran, T. Siew, and A. Khambadkone, "Composite energy storage system involving battery and ultracapacitor with dynamic energy management in microgrid applications," *IEEE Trans. Power Electron.*, vol. 26, no. 3, pp. 923-930, 2011.
- [11] S. G. Chaik and J. F. Miller, "Key challenges and recent progress in batteries, fuel cells, and hydrogen storage for clean energy systems," *J. Power Sources*, vol. 159, no. 1, pp. 73-80, 2006.
- [12] J. Bialek and D. Infield, "Energy storage and its use with intermittent renewable energy," *IEEE Trans. Energy Conversion*, vol. 19, no. 2, pp. 441-448, 2004.
- [13] K. O. Vohrbrug, "Compressed air energy storage," *J. Energy*, vol. 2, no. 2, pp. 106-112, 1978.
- [14] C. Abbey and G. Joos, "Supercapacitor energy storage for wind energy applications," *IEEE Trans. Ind. Appl.*, vol. 43, no. 3, pp. 769-776, 2007.
- [15] P. Brown, J. P. Lopes, and M. Mazer, "Optimization of pumped storage capacity in an isolated power system with large renewable penetration," *IEEE Trans. Power Syst.*, vol. 23, no. 2, pp. 523-531, 2008.
- [16] C. Abbey and G. Joos, "A stochastic optimization approach to rating of energy storage systems in wind-diesel isolated grids," *IEEE Trans. Power Syst.*, vol. 24, no. 1, pp. 418-426, 2009.
- [17] Y. Zhang, N. Gatsis, and G. Giannakis, "Robust energy management for microgrids with high-penetration renewables," *IEEE Trans. Sustainable Energy*, vol. 77, no. 99, pp. 1-10, 2013.

- [18] S. Boyd, N. Parikh, E. Chu, B. Peleato, and J. Eckstein, "Distributed optimization and statistical learning via the alternating direction method of multipliers," *Foundations Trends Mach. Learning*, vol. 3, no. 1, pp. 1-122, 2010.
- [19] G. Calafiori and M. Campi, "The scenario approach to robust control design," *IEEE Trans. Autom. Contr.*, vol. 51, no. 5, pp. 742-753, 2006.
- [20] A. Shapiro, D. Dentcheva, and A. Ruszczyński, *Lectures on Stochastic Programming: Modeling and Theory*. Philadelphia, NJ, USA: SIAM, 2009.
- [21] Y. Zhang, N. Gatsis, and G. Giannakis, "Risk-constrained energy management with multiple wind farms," in *Proc. IEEE PES Smart Grid, Feb. 2013*, pp. 1-6.
- [22] Y. Zhang, N. Gatsis, V. Kaloupek, and G. Giannakis, "Risk-aware management of distributed energy resources," in *Proc. Int. Conf. Digital Signal Process.*, Jul. 2013, pp. 1-5.
- [23] P. Yang and A. Nehorai, "Hybrid energy storage and generation planning with large renewable penetration," in *IEEE Int. Workshop Computat. Adv. Multi-Sensor Adaptive Process.*, Dec. 2013, pp. 3-4.
- [24] EPRI, "Electricity Energy Storage Technology Options: A White Paper Primer on Applications, Costs, and Benefits," Tech. Rep. EPRI, Palo Alto, CA, USA, 2010.
- [25] National Solar Radiation Data Base, [Online]. Available: http://rtdb.crrel.gov/electro/old_data/rtdb/
- [26] S. Wilson, *National Solar Radiation Database 1991 - 2010 Update: User's Manual*, 2012.
- [27] EPRI, "Renewable Energy Technical Assessment Guide - TAG-RE-2006," Tech. Rep. EPRI, Palo Alto, CA, USA, 2007.
- [28] ERCOT Hourly Load Data Archive [Online]. Available: http://www.ercot.com/gridinfo/load_hist/
- [29] M. Grant and S. Boyd, *CVX: Matlab Software for Disciplined Convex Programming, Version 2.0 Beta 2012* [Online]. Available: <http://cvxr.com/cvx>
- [30] "MISO Daily Report," 2011, Electric Power Markets: Midwest (MISO), FERC [Online]. Available: <http://www.ferc.gov/markets-overight/miso-electric/midwest/miso-archiv.aspx>
- [31] "CAISO Daily Report," 2011, Electric Power Markets: California (CAISO), FERC [Online]. Available: <http://www.ferc.gov/markets-overight/miso-electric/california/caliso-archiv.aspx>



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謹守分際-Ethics Do&Don't

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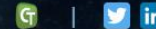


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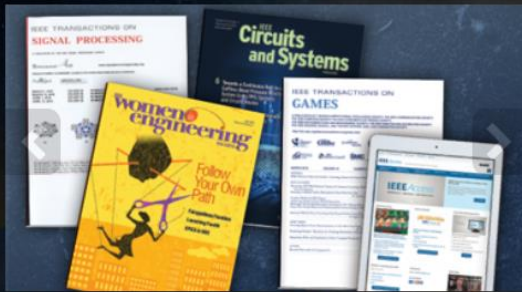
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T. C. Author is with the Electrical Engineering Department, University of Colorado, Boulder, CO 80509 USA, on leave from the National Research Institute for Metals, Tsukuba, Japan (e-mail: author@nim.go.jp).

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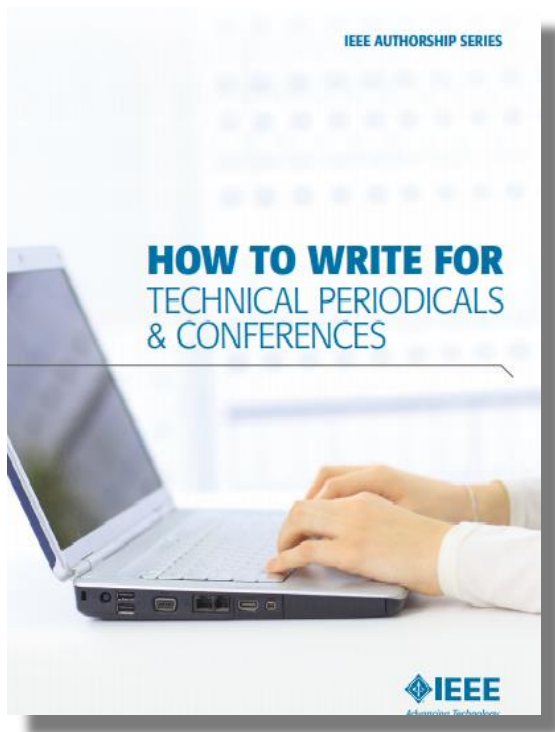
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